

# TAPE Attachment Method



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Building a part # Part # Cross Ref

-Attachment Methods

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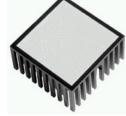
Printer Friendly Version Download our BGA Brochure (PDF)

# This is a popular item and should be available<br/>at Aavid Thermalloy's authorized distributorsFind yourlocal distributor

BGA Surface	Tape Type	Heat Sink Finish	
Metal	T405R	Black Anodize	

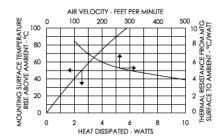
### Features and Benefits

- Tape mounting saves board space by eliminating mounting holes
- Convenient peel and stick assembly is quick and clean
- Pin Fin array allows omni -directional airflow to maximize heat dissipation



Width	Length	Height	Fin Thickness Across Width	Fin Thickness Across Length	Base Thickness	# of fins across width	# of fins across length
40.1mm	40mm	11.4mm	1.02mm	0.89mm	2.54mm	13	13

#### **Mechanical Outline Drawing**

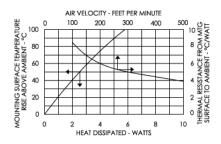


#### Unless otherwise shown, tolerances are

± 0.38( ±.015)

## **Thermal Performance**





 $^{\star}$  Natural convection thermal resistance is based on a 75 °C heat sink temperature rise.

\*\* Forced convection thermal resistance based on an entering 1.0 m/s (200 lfm) airflow. Due to various heat dissipation paths within a BGA device, please test the heat sink in your application.

This data sheet represents only one of a broad range of products we make to cool electronics. Our representatives can help you configure a complete cooling solution for your individual applications.

For more information on how to put our strengths to work for you, contact your local sales representative:

http://www.aavidthermalloy.com/sales/reps.shtml

